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February 2015

FDMC6688P P-Channel PowerTrench[®] MOSFET -20 V, -56 A, 6.5 m Ω

-20 V, -30 A, 0

- Features
- Max $r_{DS(on)}$ = 6.5 m Ω at V_{GS} = -4.5 V, I_D = -14 A
- Max $r_{DS(on)}$ = 9.8 m Ω at V_{GS} = -2.5 V, I_D = -11 A
- Max $r_{DS(on)}$ = 20 m Ω at V_{GS} = -1.8 V, I_D = -9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Lead-free and RoHS Compliant

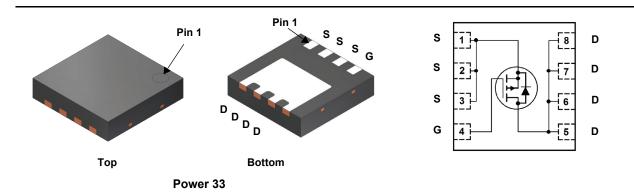


General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been optimized for $r_{DS(ON)}$, switching performance and ruggedness.

Applications

- Load Switch
- Battery Management
- Power Management
- Reverse Polarity Protection



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Paran	neter		Ratings	Units	
V _{DS}	Drain to Source Voltage			-20	V	
V _{GS}	Gate to Source Voltage			±8	V	
ID	Drain Current -Continuous	T _C = 25 °C		-56		
	-Continuous	T _A = 25 °C	(Note 1a)	-14	А	
	-Pulsed		(Note 3)	-226		
P _D	Power Dissipation	T _C = 25 °C		30		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

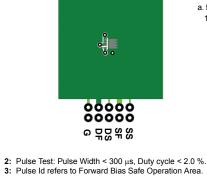
Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 53	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC6688P	FDMC6688P	Power 33	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-20			V	
ΔBV_{DSS} ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-16		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA -0.4		-0.75	-1	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		3		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = -4.5 V, I _D = -14 A		5.3	6.5	mΩ	
		V _{GS} = -2.5 V, I _D = -11 A		7	9.8		
r _{DS(on)}		V _{GS} = -1.8 V, I _D = -9 A		10.7	20		
		V_{GS} = -4.5 V, I_D = -14 A, T_J = 125 °C		7.3	11		
9 _{FS}	Forward Transconductance	V _{DS} = -5 V, I _D = -14 A		80		S	
Dvnamic	Characteristics						
C _{iss}	Input Capacitance			4956	7435	pF	
C _{oss}	Output Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		678	1020	pF	
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		618	930	pF	
R _q	Gate Resistance			4.5		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			19	35	ns	
t _r	Rise Time	V _{DD} = -10 V, I _D = -14 A,		33	53	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω		119	190	ns	
t _f	Fall Time			68	109	ns	
Q _g	Total Gate Charge			44	61	nC	
Q _{gs}	Gate to Source Charge	$V_{DD} = -10 V, I_D = -14 A,$		7.4		nC	
Q _{gd}	Gate to Drain "Miller" Charge	V _{GS} = -4.5 V		11		nC	
Drain-Soເ	urce Diode Characteristics						
、 <i>/</i>		$V_{GS} = 0 V, I_S = -14 A$ (Note 2)		-0.8	-1.2	- V	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2 A$ (Note 2)		-0.6	-1.2		
t _{rr}	Reverse Recovery Time			26	41	ns	
Q _{rr}	Reverse Recovery Charge	I _F = -14 A, di/dt = 100 A/μs		10	20	nC	

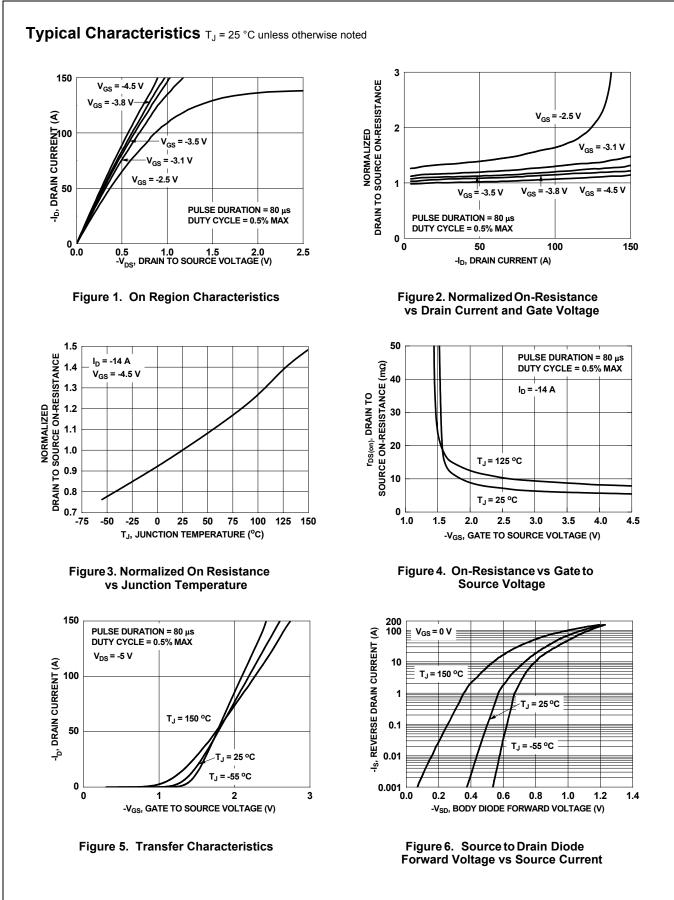


a. 53 °C/W when mounted on a 1 in² pad of 2 oz copper.



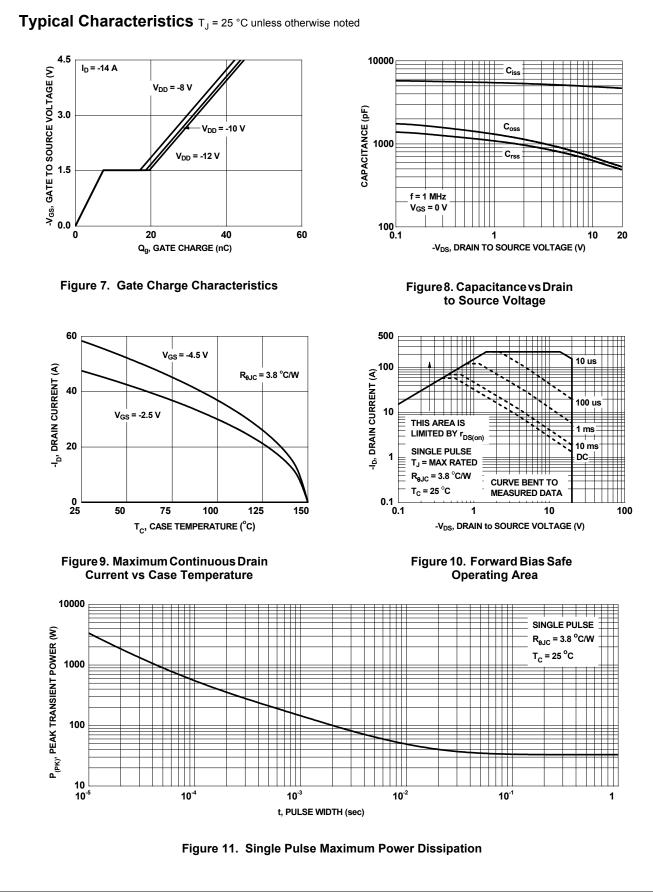
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

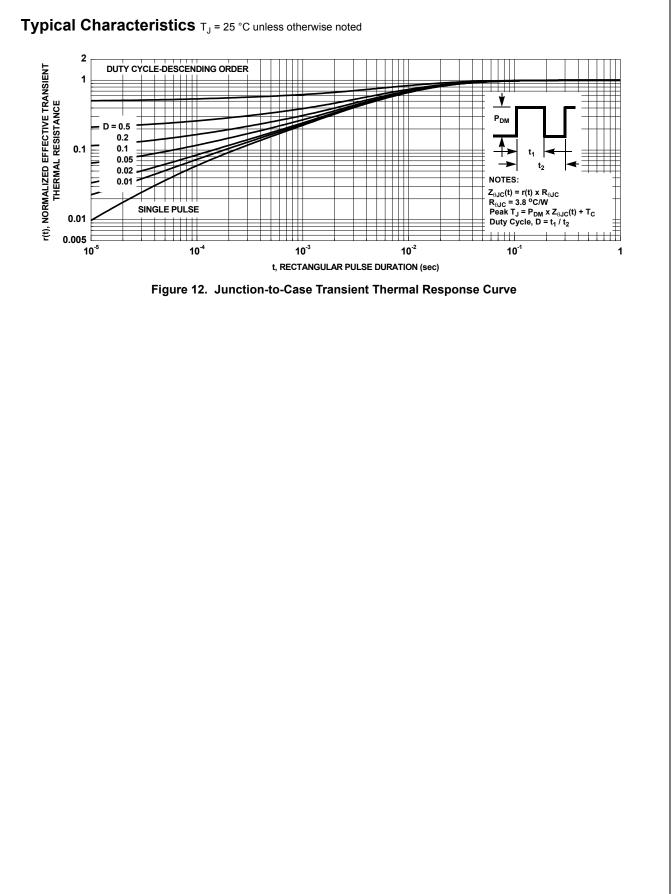
FDMC6688P P-Channel PowerTrench[®] MOSFET



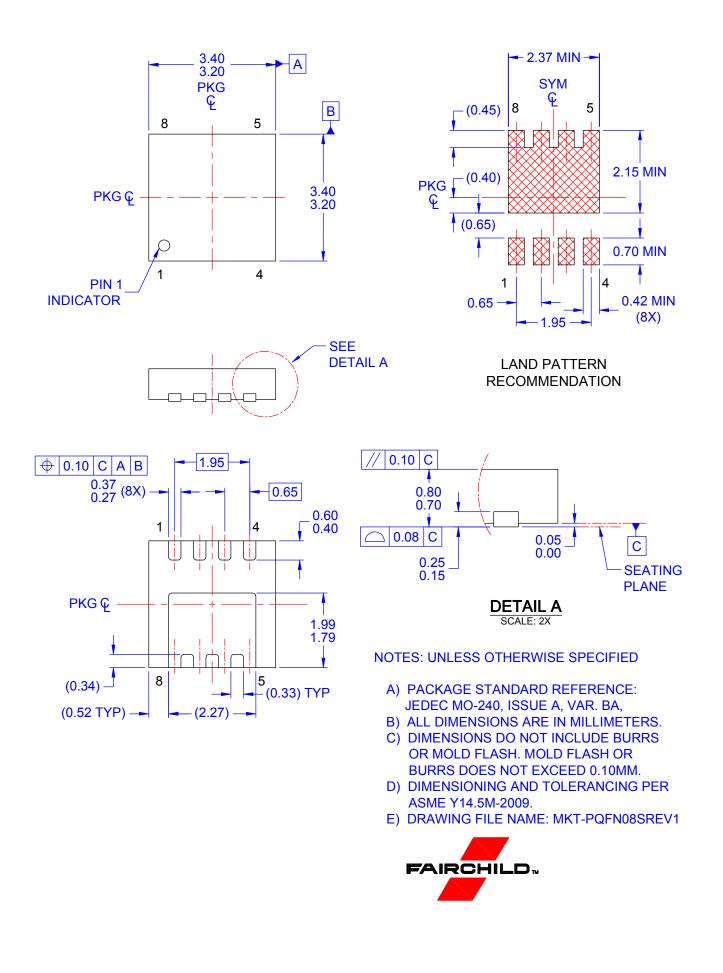
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FDMC6688P P-Channel PowerTrench[®] MOSFET



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